



CALL FOR PAPERS

ORGANIZERS

GENERAL CHAIR

Steven Brody
Product EHS Consulting

TECHNICAL PROGRAM

Deb Lord
Oracle America, Inc.



IMPORTANT DATES

Indicated deadlines require that the associated documents be loaded into the submission portal, EDAS, (<http://edas.info>) by the due date:

August 1, 2018

Initial Paper/Presentation
Deadline

August 15, 2018

Notification Deadline

September 4, 2018

Final Paper/Presentation Deadline

The IEEE Product Safety Engineering Society hosts a premier symposium annually on all relevant topics for workers and innovators in the product safety area. Join us in Boston, Massachusetts for ISPCE 2018 for three days of technical sessions and exhibits!

PAPER SUBMISSION

Please go to the Submission page on the SPCE website for details & comprehensive submission instructions, including separate formal paper and presentation templates.

Formal papers & presentations not submitted per submission instructions by the initial deadline may need to be held over until next year depending on the number of submissions.

Please note, when serving as an educational presenter during SPCE 2018, speakers are permitted to introduce themselves and make reference to the company they represent, or their company activities, as is necessary for context within the course of their presentation. Company sales or other promotional activities should be reserved for other times.

TOPIC AREAS

The IEEE Product Safety Engineering Society seeks original and unpublished formal papers, presentations (without formal papers), workshops, and tutorials on all aspects of product safety and compliance engineering including, but not limited to:

- Global Market Access & Regulations, Compliance Management
- EMC & Wireless Compliance
- Environmental & Energy Regulations
- Batteries & Energy Storage Systems
- Medical Devices
- Compliance 101
- Hazard Based Safety
- Engineering & Safety Science
- Forensics, Failure & Risk Analysis, Assessment & Management
- Legal, Regulations, Directives & Consumer Protection
- Emerging Technologies & Innovations